

PZT751T1

Preferred Device

PNP Silicon Planar Epitaxial Transistor

This PNP Silicon Epitaxial transistor is designed for use in industrial and consumer applications. The device is housed in the SOT-223 package which is designed for medium power surface mount applications.

Features

- High Current: 2.0 A
- The SOT-223 Package can be soldered using wave or reflow.
- SOT-223 package ensures level mounting, resulting in improved thermal conduction, and allows visual inspection of soldered joints. The formed leads absorb thermal stress during soldering, eliminating the possibility of damage to the die
- NPN Complement is PZT651T1
- Pb-Free Package is Available

MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CEO}	60	Vdc
Collector-Base Voltage	V_{CBO}	80	Vdc
Emitter-Base Voltage	V_{EBO}	5.0	Vdc
Collector Current	I_C	2.0	Adc
Total Power Dissipation @ $T_A = 25^\circ\text{C}^{(1)}$ Derate above 25°C	P_D	0.8 6.4	W mW/°C
Storage Temperature Range	T_{stg}	-65 to 150	°C
Junction Temperature	T_J	150	°C

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Resistance from Junction-to-- Ambient in Free Air	$R_{\theta JA}$	156	°C/W
Maximum Temperature for Soldering Purposes Time in Solder Bath	T_L	260 10	°C Sec

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

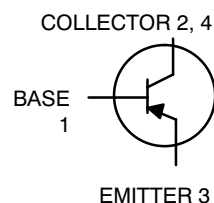
1. Device mounted on a FR-4 glass epoxy printed circuit board using minimum recommended footprint.



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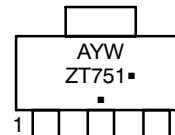
SOT-223 PACKAGE HIGH CURRENT PNP SILICON TRANSISTOR SURFACE MOUNT



MARKING DIAGRAM



TO-261AA
CASE 318E
STYLE 1



A = Assembly Location
Y = Year
W = Work Week
▪ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping
PZT751T1	SOT-223	1000 / Tape & Reel
PZT751T1G	SOT-223 (Pb-Free)	1000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

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ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristics	Symbol	Min	Max	Unit
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OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage (I _C = 10 mA _{dc} , I _B = 0)	V _{(BR)CEO}	60	-	V _{dc}
Collector-Emitter Breakdown Voltage (I _C = 100 μA _{dc} , I _E = 0)	V _{(BR)CBO}	80	-	V _{dc}
Emitter-Base Breakdown Voltage (I _E = 10 μA _{dc} , I _C = 0)	V _{(BR)EBO}	5.0	-	V _{dc}
Base-Emitter Cutoff Current (V _{EB} = 4.0 V _{dc})	I _{EBO}	-	0.1	μA _{dc}
Collector-Base Cutoff Current (V _{CB} = 80 V _{dc} , I _E = 0)	I _{CBO}	-	100	nA _{dc}

ON CHARACTERISTICS (Note 2)

DC Current Gain (I _C = 50 mA _{dc} , V _{CE} = 2.0 V _{dc}) (I _C = 500 mA _{dc} , V _{CE} = 2.0 V _{dc}) (I _C = 1.0 A _{dc} , V _{CE} = 2.0 V _{dc}) (I _C = 2.0 A _{dc} , V _{CE} = 2.0 V _{dc})	h _{FE}	75 75 75 40	- - - -	-
Collector-Emitter Saturation Voltages (I _C = 2.0 A _{dc} , I _B = 200 mA _{dc}) (I _C = 1.0 A _{dc} , I _B = 100 mA _{dc})	V _{CE(sat)}	- -	0.5 0.3	V _{dc}
Base-Emitter Voltages (I _C = 1.0 A _{dc} , V _{CE} = 2.0 V _{dc})	V _{BE(on)}	-	1.0	V _{dc}
Base-Emitter Saturation Voltage (I _C = 1.0 A _{dc} , I _B = 100 mA _{dc})	V _{BE(sat)}	-	1.2	V _{dc}
Current-Gain-Bandwidth (I _C = 50 mA _{dc} , V _{CE} = 5.0 V _{dc} , f = 100 MHz)	f _T	75	-	MHz

2. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle = 2.0%.

PZT751T1

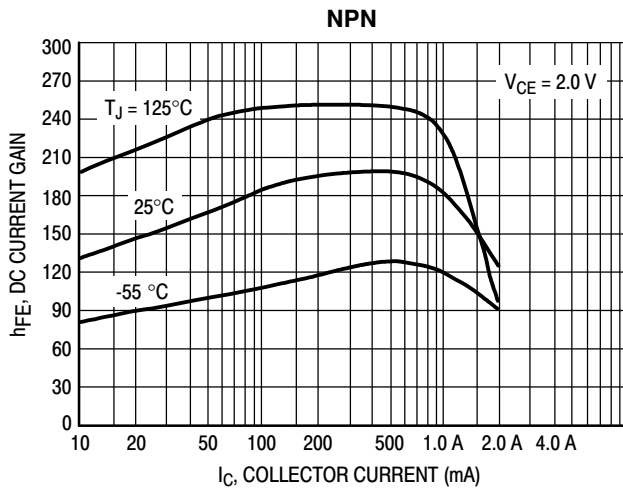


Figure 1. Typical DC Current Gain

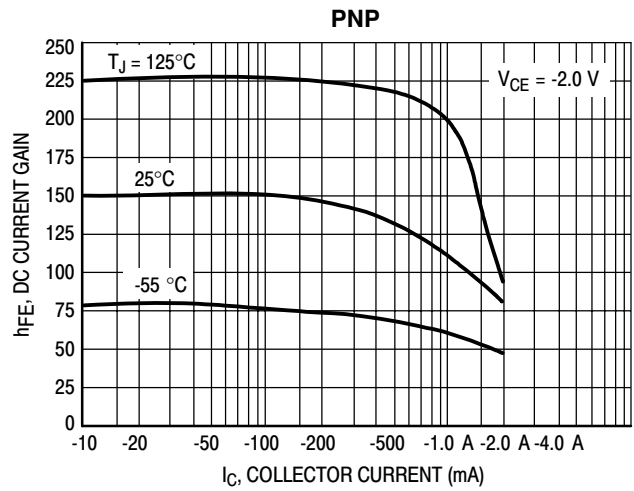


Figure 2. Typical DC Current Gain

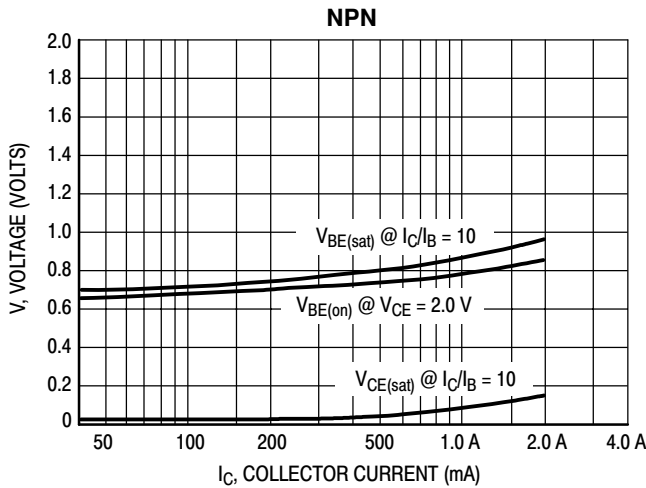


Figure 3. On Voltages

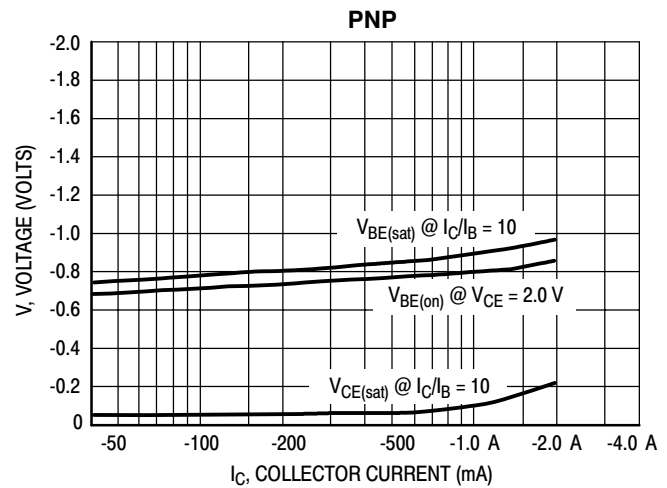


Figure 4. On Voltages

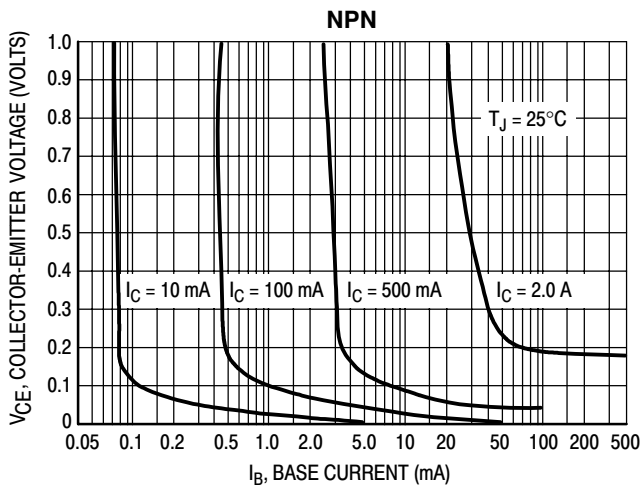


Figure 5. Collector Saturation Region

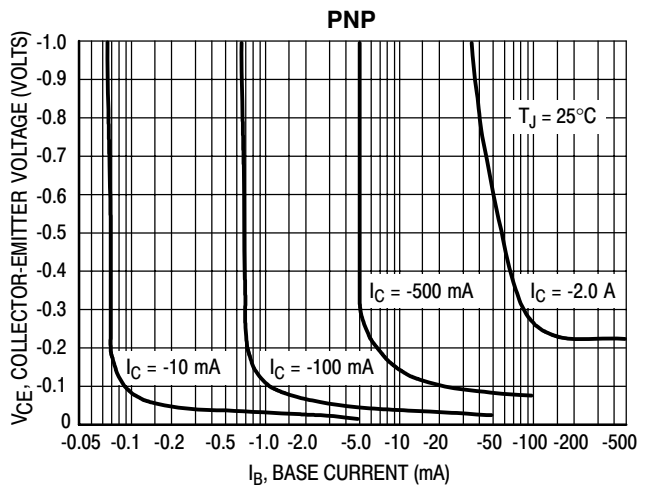


Figure 6. Collector Saturation Region

